34 STM32F446xx devices bootloader

34.1 Bootloader configuration

The STM32F446xx bootloader is activated by applying pattern1 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 70.STM32F446xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
Common to all bootloaders	RCC	HSI enabled	The HSI is used at startup as clock source for system clock configured to 60 MHz and for USART, I2C and SPI bootloader operation.
		HSE enabled	The HSE is used only when the CAN or the DFU (USB FS Device) interfaces are selected. In this case the system clock configured to 60 MHz with HSE as clock source. The HSE frequency must be multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
	RAM	-	12 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	29 Kbyte starting from address 0x1FFF0000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	The voltage range is [1.71 V, 3.6 V]. In this range: - Flash wait states 3. - System Clock 60 MHz. - Prefetch disabled. - Flash write operation by byte (refer to section bootloader memory management for more information).

Table 70.STM32F446xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
USART1 bootloader	USART1	Enabled	Once initialized the USART1 configuration is: 8-bits, even parity and 1 Stop bit
	USART1_RX pin	Input	PA10 pin: USART1 in reception mode
	USART1_TX pin	Output	PA9 pin: USART1 in transmission mode
USART3 bootloader (on PB10/PB11)	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
	USART3_RX pin	Input	PB11 pin: USART3 in reception mode
	USART3_TX pin	Output	PB10 pin: USART3 in transmission mode
USART3 bootloader (on PC10/PC11)	USART3	Enabled	Once initialized the USART3 configuration is: 8-bits, even parity and 1 Stop bit
	USART3_RX pin	Input	PC11 pin: USART3 in reception mode
	USART3_TX pin	Output	PC10 pin: USART3 in transmission mode
USARTx bootloaders	SysTick timer	Enabled	Used to automatically detect the serial baud rate from the host for USARTx bootloaders.
CAN2 bootloader	CAN2	Enabled	Once initialized the CAN2 configuration is: Baudrate 125 kbps, 11-bit identifier. **Note:** CAN1 is clocked during CAN2 bootloader execution because in CAN1 manages the communication between CAN2 and SRAM.
	CAN2_RX pin	Input	PB5 pin: CAN2 in reception mode
	CAN2_TX pin	Output	PB13 pin: CAN2 in transmission mode
I2C1 bootloader	I2C1	Enabled	The I2C1 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111100x (where x = 0 for write and x = 1 for read)
	I2C1_SCL pin	Input/Output	PB6 pin: clock line is used in open-drain mode.
	I2C1_SDA pin	Input/Output	PB9 pin: data line is used in open-drain mode.
I2C2 bootloader	I2C2	Enabled	The I2C2 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111100x (where x = 0 for write and x = 1 for read)
	I2C2_SCL pin	Input/Output	PF1 pin: clock line is used in open-drain mode.
	I2C2_SDA pin	Input/Output	PF0 pin: data line is used in open-drain mode.

Table 70.STM32F446xx configuration in system memory boot mode (continued)

Bootloader	Feature/Peripheral	State	Comment
I2C3 bootloader	I2C3	Enabled	The I2C3 configuration is: I2C speed: up to 400 KHz, 7-bit address, slave mode, analog filter ON. Slave 7-bit address: 0b0111100x (where x = 0 for write and x = 1 for read)
	I2C3_SCL pin	Input/Output	PA8 pin: clock line is used in open-drain mode.
	I2C3_SDA pin	Input/Output	PC9 pin: data line is used in open-drain mode.
SPI1 bootloader	SPI1	Enabled	The SPI1 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI1_MOSI pin	Input	PA7 pin: Slave data Input line, used in Push-pull pull-down mode
	SPI1_MISO pin	Output	PA6 pin: Slave data output line, used in Push-pull pull-down mode
	SPI1_SCK pin	Input	PA5 pin: Slave clock line, used in Push-pull pull-down mode
	SPI1_NSS pin	Input	PA4 pin: slave chip select pin used in Push-pull pull-up mode.
SPI2 bootloader	SPI2	Enabled	The SPI2 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI2_MOSI pin	Input	PB15 pin: Slave data Input line, used in Push-pull pull-down mode
	SPI2_MISO pin	Output	PB14 pin: Slave data output line, used in Push-pull pull-down mode
	SPI2_SCK pin	Input	PC7 pin: Slave clock line, used in Push-pull pull-down mode
	SPI2_NSS pin	Input	PB12 pin: slave chip select pin used in Push-pull pull-up mode.

Table 70.STM32F446xx configuration in system memory boot mode (continued)

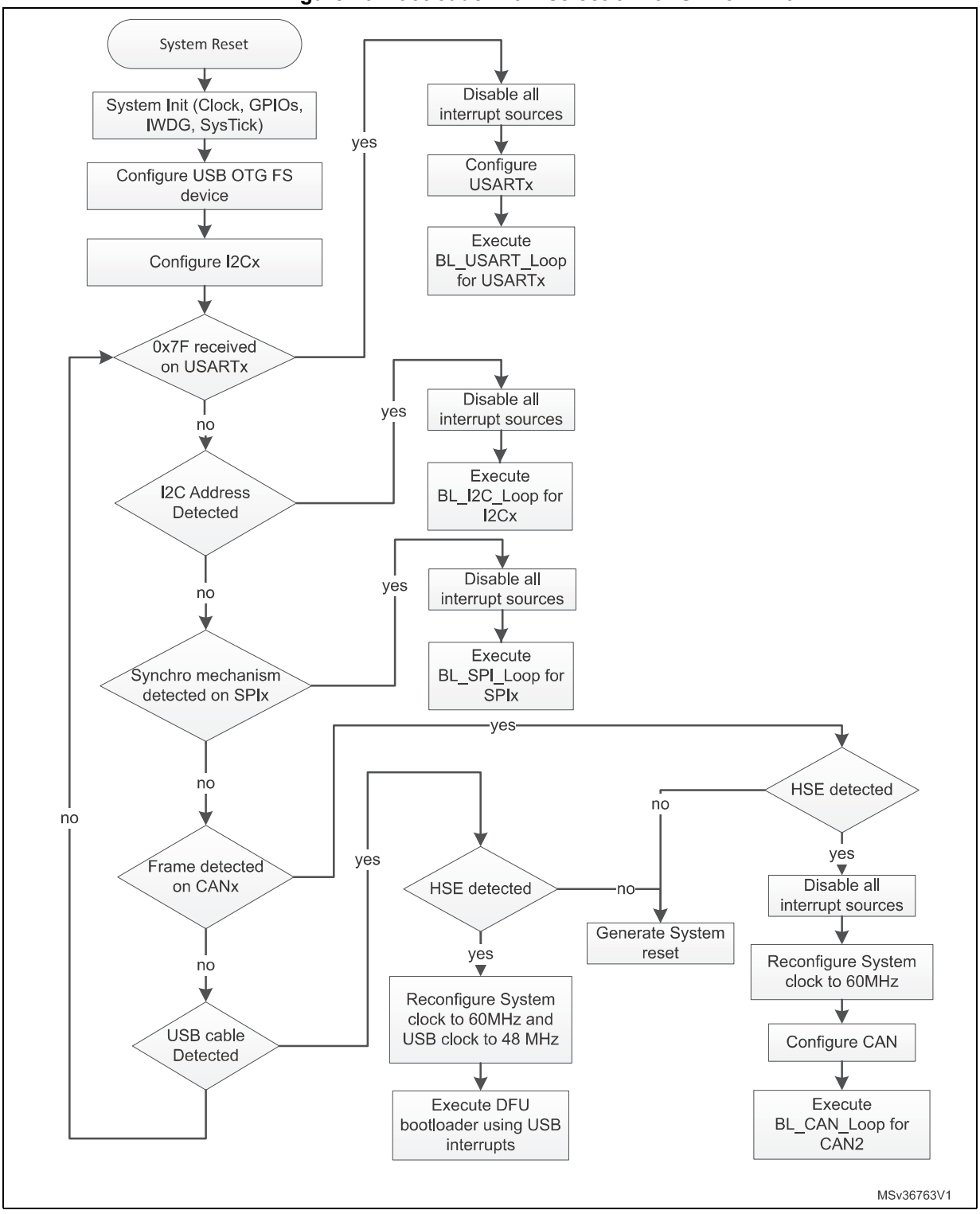
Bootloader	Feature/Peripheral	State	Comment
SPI4 bootloader	SPI4	Enabled	The SPI4 configuration is: Slave mode, Full Duplex, 8-bit MSB, Speed up to 8 MHz, Polarity: CPOL Low, CPHA Low, NSS hardware.
	SPI4_MOSI pin	Input	PE14 pin: Slave data Input line, used in Push-pull pull-down mode
	SPI4_MISO pin	Output	PE13 pin: Slave data output line, used in Push-pull pull-down mode
	SPI4_SCK pin	Input	PE12 pin: Slave clock line, used in Push-pull pull-down mode
	SPI4_NSS pin	Input	PE11 pin: slave chip select pin used in Push-pull pull-up mode.
DFU bootloader	USB	Enabled	USB OTG FS configured in forced device mode
	USB_DM pin	Input/Output	PA11: USB DM line.
	USB_DP pin		PA12: USB DP line No external Pull-up resistor is required
CAN2 and DFU bootloaders	TIM17	Enabled	This timer is used to determine the value of the HSE. Once the HSE frequency is determinated, the system clock is configured to 60 MHz using PLL and HSE.

The system clock is derived from the embedded internal high-speed RC for USARTx and I2Cx bootloaders. This internal clock is also used for CAN and DFU (USB FS Device) but only for the selection phase. An external clock multiple of 1 MHz (between 4 and 26 MHz) is required for CAN and DFU bootloader execution after the selection phase.

34.2 Bootloader selection

The figure below shows the bootloader selection mechanism.

Figure 40.Bootloader V9.x selection for STM32F446xx



34.3 Bootloader version

The following table lists the STM32F446xx devices bootloader V9.x versions:

Table 71. STM32F446xx bootloader V9.x versions

Bootloader version number	Description	Known limitations
V9.0	Initial bootloader version	After executing Go command (jump to user code) the bootloader resets AHB1ENR value to 0x0000 0000 and thus CCM RAM, when present, is not active (shall be re-enabled by user code at startup)

35 STM32F469xx/479xx devices bootloader

35.1 Bootloader configuration

The STM32F469xx/479xx bootloader is activated by applying pattern5 (described in *Table 2: Bootloader activation patterns*). The following table shows the hardware resources used by this bootloader.

Table 72. STM32F469xx/479xx configuration in system memory boot mode

Bootloader	Feature/Peripheral	State	Comment
Common to all bootloaders	RCC	HSI enabled	The system clock frequency is 60 MHz using the PLL. The HSI clock source is used at startup (interface detection phase) and when USART or SPI or I2C interfaces are selected (once CAN or DFU bootloader is selected, the clock source will be derived from external crystal).
		HSE enabled	The system clock frequency is 60 MHz. The HSE clock source is used only when the CAN or the DFU (USB FS Device) interfaces are selected. The external clock must provide a frequency multiple of 1 MHz and ranging from 4 MHz to 26 MHz.
		-	The Clock Security System (CSS) interrupt is enabled for the CAN and DFU bootloaders. Any failure (or removal) of the external clock generates system reset.
	RAM	-	12 Kbyte starting from address 0x20000000 are used by the bootloader firmware
	System memory	-	29 Kbyte starting from address 0x1FFF0000, contain the bootloader firmware
	IWDG	-	The independent watchdog (IWDG) prescaler is configured to its maximum value. It is periodically refreshed to prevent watchdog reset (in case the hardware IWDG option was previously enabled by the user).
	Power	-	Voltage range is set to [1.62 V, 2.1 V]. In this range internal Flash write operations are allowed only in byte format (Half-Word, Word and Double-Word operations are not allowed). The voltage range can be configured in run time using bootloader commands.